



REV.	REVISIONS	REC.	DATE	REV.	REVISIONS	REC.	DATE
1	端子材質硬度由:1/2H→H		'06.04.17	4	(N1): 9.85→9.95; 且高壓側標記 $\triangle$ 處尺寸:0.4→0.6		'07.05.22
2	低壓側假PIN 處過線槽結構設變, 詳見標記 $\triangle$ 處		'06.12.14				
3	(N1): 9.70→9.85		'07.04.09				

DRAWN & DRAFTED BY HOU YI MIN	TOLERANCES		ANGLE: $\pm 1^\circ$	TITLE: UI-9.8-C SMD BOBBIN		
	$\pm 0.1$	COPLANARITY 0.1 MAX	UNIT: MM	BOBBIN MATERIAL: LCP E4008		UL REC. UL 94V-0
CHECKED & APPROVED BY			ORIGIN: SZ	PIN MATERIAL: PHOSPHOR BRONZE(H)		PIN TENSION LOAD: 2.0KG MIN
<b>PIN SHINE INDUSTRIAL CO., LTD.</b> TEL:886-2-22990545      FAX:886-2-22990546				DATE: JUN.16 '2005	DRAWING NO. S-914-4	REV. 4